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Heatsinks for LEDs / **ICK LED R 27 x 10 G**   

Ø 27 x 10 mm, for IC design LED

Parameters of article ICK LED R 27 x 10 G

R_{th} [K/W]	 18.24
dissipation loss [W]	 6.6
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
Ø [mm]	 27
height [mm]	10
plate thickness [mm]	3
surface treatment	black anodised

[Technical Drawing](#)**Accessories/ related articles**Thermally conductive foil both sides adhesive / **WLFT 404 D 27**Thermally conductive foil both sides adhesive / **WLFT 405 D 27****Download CAD Drawing**

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